

HOU-WAN LONG

Room 232A, Mei Yun Tang, The Chinese University of Hong Kong, Shatin, Hong Kong

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EDUCATION

The Chinese University of Hong Kong—CGPA:3.564; MGPA:3.7

Hong Kong

- B.Sc. in Risk Management Science (expected May 2026)
- Core Course Modules: Statistics, Finance and Computer Science

September 2022 - Present

Washington University in St. Louis

St. Louis, Missouri

- Exchange Student

January 2025 - Present

RESEARCH INTEREST

Computational Social Science, AI for Finance, Decentralized Mechanism

PUBLICATIONS

Conference Proceedings

- **H.-W. Long**, N.-M. Wong, W. Cai, Bridging Culture and Finance: A Multimodal Analysis of Memecoins in the Web3 Ecosystem, The ACM Web Conference 2025 (WWW'25) Short Paper (**Accepted**)
- **H.-W. Long**, Y.-W. Si, Token Fungibility Duality: Technical and Graphical Analysis on 404 Standards, IEEE International Conference on Blockchain (**Acceptance Rate=18.89%**)
- **H.-W. Long**, X. Zhao, Y.-W. Si, Dynamic Mining Interval to Improve Blockchain Throughput, IEEE International Conference on Big Data (**Acceptance Rate=17.4%**)

Journals

- J. Sun, **H.-W. Long**, Z. Fang, A El Saddik, W. Cai, Contract Design for SCaaS with Multi-dimensional Private Information, IEEE Transactions on Computational Social Systems (**JCR Q1**)
- X. Zhao, G. Zhang, **H.-W. Long**, Y.-W. Si., Verkle Tree-Based Dynamic Transaction Storage Strategies for Minimizing the Volatility of Block Incentives, Decision Support Systems (**JCR Q1**)
- X. Zhao, **H.-W. Long**, Y.-W. Si, Mitigating Blockchain extractable value (BEV) threats by Distributed Transaction Sequencing in Blockchains, Journal of Digital Communications and Networks (**JCR Q1, Minor Revision**)

RESEARCH EXPERIENCE

Decentralized Computing Laboratory, University of Washington

Tacoma, Washington

Research Assistant (remote)

March 2024 - December 2024

Data Analytics and Collaborative Computing Laboratory, University of Macau

Macau

Research Assistant

March 2023 - February 2024

HONOURS AND AWARDS

- **Reaching Out Award** by New Asia College, The Chinese University of Hong Kong *May 2023*
- **Student Travel Award** by Institute of Electrical and Electronics Engineers (IEEE) *November 2023*
- **Research Studentship** by Department of Statistics, The Chinese University of Hong Kong *December 2023*
- **Dean's List** by Department of Statistics, The Chinese University of Hong Kong *July 2024*

SKILLS

Skills: Pytorch, Pandas, Selenium

Languages: English (fluent), Cantonese (native), Mandarin (native)